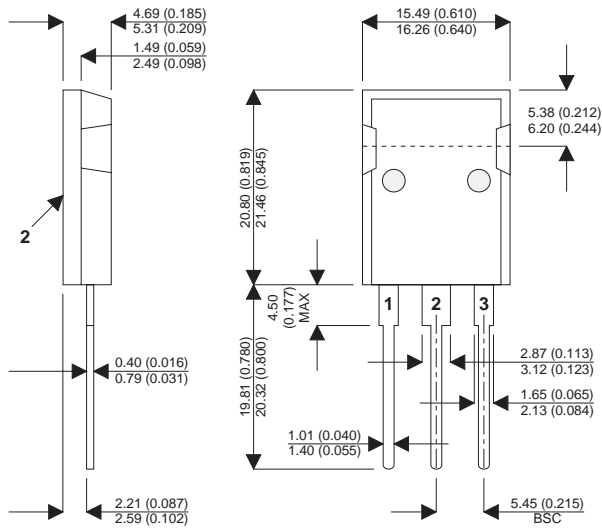


T247clip Package Outline.

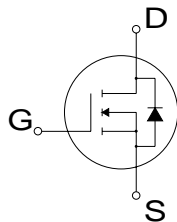
Dimensions in mm (inches)



Pin 1 – Gate

Pin 2 – Drain

Pin 3 – Source



**N-CHANNEL  
ENHANCEMENT MODE  
HIGH VOLTAGE  
POWER MOSFETS**

$V_{DSS}$       **100V**  
 $I_{D(cont)}$     **100A**  
 $R_{DS(on)}$     **0.011Ω**

- **Faster Switching**
- **Lower Leakage**
- **100% Avalanche Tested**
- **New T247clip Package (Clip-mounted TO-247 Package)**

StarMOS is a new generation of high voltage N-Channel enhancement mode power MOSFETs. This new technology minimises the JFET effect, increases packing density and reduces the on-resistance. StarMOS also achieves faster switching speeds through optimised gate layout.

**ABSOLUTE MAXIMUM RATINGS** ( $T_{case} = 25^{\circ}C$  unless otherwise stated)

$V_{DSS}$	Drain – Source Voltage	100	V
$I_D$	Continuous Drain Current	100	A
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	400	A
$V_{GS}$	Gate – Source Voltage	±30	V
$V_{GSM}$	Gate – Source Voltage Transient	±40	
$P_D$	Total Power Dissipation @ $T_{case} = 25^{\circ}C$	520	W
	Derate Linearly	4.16	W/°C
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to 150	°C
$T_L$	Lead Temperature : 0.063" from Case for 10 Sec.	300	
$I_{AR}$	Avalanche Current <sup>1</sup> (Repetitive and Non-Repetitive)	100	A
$E_{AR}$	Repetitive Avalanche Energy <sup>1</sup>	50	mJ
$E_{AS}$	Single Pulse Avalanche Energy <sup>2</sup>	2500	

1) Repetitive Rating: Pulse Width limited by maximum junction temperature.

2) Starting  $T_J = 25^{\circ}C$ ,  $L = 500\mu H$ ,  $R_G = 25\Omega$ , Peak  $I_L = 100A$

**STATIC ELECTRICAL RATINGS** ( $T_{case} = 25^{\circ}C$  unless otherwise stated)

	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain – Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	100			V
$I_{DSS}$	Zero Gate Voltage Drain Current ( $V_{GS} = 0V$ )	$V_{DS} = V_{DSS}$			250	$\mu A$
		$V_{DS} = 0.8V_{DSS}, T_C = 125^{\circ}C$			1000	
$I_{GSS}$	Gate – Source Leakage Current	$V_{GS} = \pm 30V, V_{DS} = 0V$			$\pm 100$	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 2.5mA$	2		4	V
$I_{D(ON)}$	On State Drain Current <sup>2</sup>	$V_{DS} > I_{D(ON)} \times R_{DS(ON)}$ Max $V_{GS} = 10V$	100			A
$R_{DS(ON)}$	Drain – Source On State Resistance <sup>2</sup>	$V_{GS} = 10V, I_D = 0.5 I_D [Cont.]$			0.011	$\Omega$

**DYNAMIC CHARACTERISTICS**

	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
$C_{iss}$	Input Capacitance	$V_{GS} = 0V$		8600		pF
$C_{oss}$	Output Capacitance	$V_{DS} = 25V$		3250		
$C_{rss}$	Reverse Transfer Capacitance	$f = 1MHz$		1180		
$Q_g$	Total Gate Charge <sup>3</sup>	$V_{GS} = 10V$		310		nC
$Q_{gs}$	Gate – Source Charge	$V_{DD} = 0.5 V_{DSS}$		95		
$Q_{gd}$	Gate – Drain (“Miller”) Charge	$I_D = I_D [Cont.] @ 25^{\circ}C$		120		
$t_{d(on)}$	Turn-on Delay Time	$V_{GS} = 15V$		16		ns
$t_r$	Rise Time	$V_{DD} = 0.5 V_{DSS}$		33		
$t_{d(off)}$	Turn-off Delay Time	$I_D = I_D [Cont.] @ 25^{\circ}C$		46		
$t_f$	Fall Time	$R_G = 0.6\Omega$		8		

**SOURCE – DRAIN DIODE RATINGS AND CHARACTERISTICS**

	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous Source Current	(Body Diode)			100	A
$I_{SM}$	Pulsed Source Current <sup>1</sup>	(Body Diode)			400	
$V_{SD}$	Diode Forward Voltage <sup>2</sup>	$V_{GS} = 0V, I_S = -I_D [Cont.]$			1.3	V
$t_{rr}$	Reverse Recovery Time	$I_S = -I_D [Cont.], di_S / dt = 100A/\mu s$		250		ns
$Q_{rr}$	Reverse Recovery Charge	$I_S = -I_D [Cont.], di_S / dt = 100A/\mu s$		2.5		$\mu C$

**THERMAL CHARACTERISTICS**

	Characteristic	Min.	Typ.	Max.	Unit
$R_{\theta JC}$	Junction to Case			0.24	$^{\circ}C/W$
$R_{\theta JA}$	Junction to Ambient			40	

1) Repetitive Rating: Pulse Width limited by maximum junction temperature.

2) Pulse Test: Pulse Width < 380 $\mu s$ , Duty Cycle < 2%

3) See MIL-STD-750 Method 3471



CAUTION — Electrostatic Sensitive Devices. Anti-Static Procedures Must Be Followed.

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